



# N-Channel 30 V (D-S) MOSFET

| PRODUCT SUMMARY     |                                      |                                 |    |  |  |
|---------------------|--------------------------------------|---------------------------------|----|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}(\Omega)$                 | $R_{DS(on)}(\Omega)$ $I_{D}(A)$ |    |  |  |
| 30                  | 0.0039 at V <sub>GS</sub> = 10 V     | 107 <sup>d</sup>                | 67 |  |  |
| 30                  | $0.0045$ at $V_{GS} = 4.5 \text{ V}$ | 103 <sup>d</sup>                | 07 |  |  |

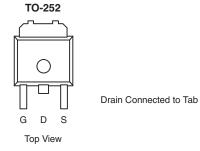
### **FEATURES**

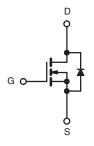
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>q</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

## ROHS COMPLIANT HALOGEN FREE

### **APPLICATIONS**

- DC/DC Converters
  - Synchronous Buck Low Side





Ordering Information: SUD42N03-3m9P-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

|  | <b>RATINGS</b> ( $T_C = 25  ^{\circ}C$ , unless other | · · · · · · · · ·                 |                   |    |  |
|--|---|-----------------------------------|-------------------|----|--|
| Parameter  | Symbol  | Limit                             | Unit              |    |  |
| Drain-Source Voltage                             | $V_{DS}$  | 30                                | V                 |    |  |
| Gate-Source Voltage                              | $V_{GS}$  | ± 20                              |                   |    |  |
| Continuous Drain Current                         | T <sub>C</sub> = 25 °C (Silicon Limited)              |                                   | 107 <sup>d</sup>  |    |  |
|  | T <sub>C</sub> = 70 °C (Silicon Limited)              | I <sub>D</sub>                    | 85 <sup>d</sup>   |    |  |
|  | T <sub>C</sub> = 25 °C (Package Limited)              | ] [                               | 42                | Α  |  |
| Pulsed Drain Current (t = 300 μs)                | I <sub>DM</sub>                                       | 120                               |                   |    |  |
| Avalanche Current                                |   | I <sub>AS</sub>                   | 45                |    |  |
| Single Avalanche Energy <sup>a</sup>             | L = 0.1 mH  | E <sub>AS</sub>                   | 101               | mJ |  |
| Maximum Power Dissipation <sup>a</sup>           | T <sub>C</sub> = 25 °C                                | В                                 | 73.5 <sup>b</sup> | W  |  |
| Maximum Fower Dissipation                        | T <sub>A</sub> = 25 °C <sup>c</sup>                   | P <sub>D</sub>                    | 2.5               |    |  |
| Operating Junction and Storage Temperature Range |   | T <sub>J</sub> , T <sub>stq</sub> | - 55 to 150       | °C |  |

| THERMAL RESISTANCE RATINGS                   |                   |       |      |  |  |  |
|--|-------------------|-------|------|--|--|--|
| Parameter                                    | Symbol            | Limit | Unit |  |  |  |
| Junction-to-Ambient (PCB Mount) <sup>c</sup> | R <sub>thJA</sub> | 50    | °C/W |  |  |  |
| Junction-to-Case (Drain)                     | R <sub>thJC</sub> | 1.7   |      |  |  |  |

### Notes

- a. Duty cycle  $\leq$  1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 42 A.

## SUD42N03-3m9P

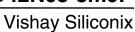
# Vishay Siliconix



| Parameter                                     | Symbol                                 | Test Conditions  | Min. | Тур.   | Max.   | Unit |  |
|---|--|--|------|--------|--------|------|--|
| Static  |  |  |      |        |        |      |  |
| Drain-Source Breakdown Voltage                | $V_{DS}$                               | V <sub>DS</sub> = 0 V, I <sub>D</sub> = 250 μA                         | 30   |        |        |      |  |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub>                    | $V_{DS} = V_{GS}, I_D = 250 \mu A$                                     | 1    |        | 2.5    | V    |  |
| Gate-Body Leakage                             | I <sub>GSS</sub>                       | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$                      |      |        | ± 250  | nA   |  |
|   |  | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V                          | 1    |        |        |      |  |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>                       | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C |      |        | 50     | μΑ   |  |
|   |  | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C |      |        | 250    | 1    |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>                     | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$                       | 50   |        |        | Α    |  |
| Dunin Course On Chata Basistanasa             |  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22 A                          |      | 0.0032 | 0.0039 | Ω    |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>                    | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A                         |      | 0.0037 | 0.0045 |      |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>                        | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A                          |      | 110    |        | S    |  |
| Dynamic <sup>b</sup>                          |  |  |      |        |        |      |  |
| Input Capacitance                             | C <sub>iss</sub>                       |  |      | 3535   |        | pF   |  |
| Output Capacitance                            | C <sub>oss</sub>                       | $V_{GS} = 0 \text{ V}, V_{DS} = 15 \text{ V}, f = 1 \text{ MHz}$       |      | 680    |        |      |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>                       |  |      | 400    |        |      |  |
| Total Gate Charge <sup>c</sup>                | Qg                                     |  |      | 67     | 100    | nC   |  |
| Gate-Source Charge <sup>c</sup>               | $Q_{gs}$                               | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$     |      | 10.5   |        |      |  |
| Gate-Drain Charge <sup>c</sup>                | $Q_{gd}$                               |  |      | 12.2   |        |      |  |
| Gate Resistance                               | $R_{g}$                                | f = 1 MHz  | 0.3  | 1.4    | 2.8    | Ω    |  |
| Turn-On Delay Time <sup>c</sup>               | t <sub>d(on)</sub>                     |  |      | 11     | 20     |      |  |
| Rise Time <sup>c</sup>                        | t <sub>r</sub>                         | $V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$                            |      | 10     | 20     | ns   |  |
| Turn-Off Delay Time <sup>c</sup>              | t <sub>d(off)</sub>                    | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$       |      | 35     | 53     |      |  |
| Fall Time <sup>c</sup>                        | t <sub>f</sub>                         |  |      | 10     | 20     |      |  |
| Drain-Source Body Diode Ratings at            | nd Characteris                         | stics <sup>b</sup> T <sub>C</sub> = 25 °C                              | •    | •      |        |      |  |
| Continuous Current                            | I <sub>S</sub>                         |  |      |        | 42     | A    |  |
| Pulsed Current                                | I <sub>SM</sub>                        |  |      |        | 120    |      |  |
| Forward Voltage <sup>a</sup>                  | $V_{SD}$                               | I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V                           |      | 0.83   | 1.5    | ٧    |  |
| Reverse Recovery Time                         | t <sub>rr</sub>                        |  |      | 41     | 62     | ns   |  |
| Peak Reverse Recovery Current                 | I <sub>RM(REC)</sub>                   | $I_F = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$                |      | 2      | 3      | Α    |  |
| Reverse Recovery Charge                       | everse Recovery Charge Q <sub>rr</sub> |  |      | 40     | 60     | nC   |  |

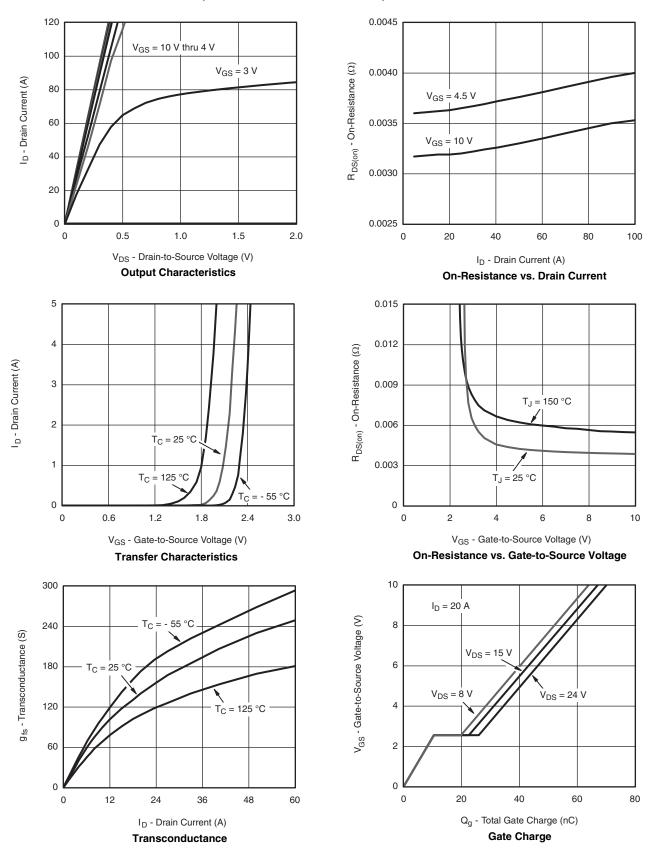
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





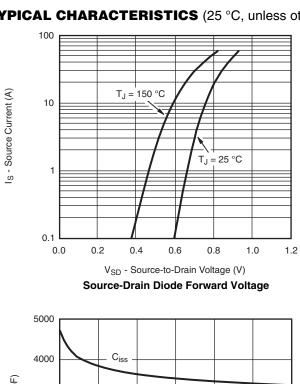
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

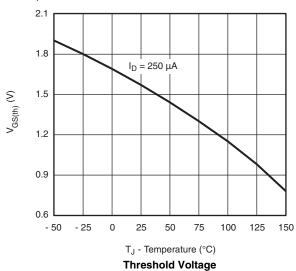


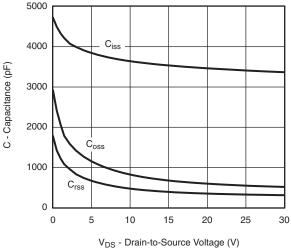
## SUD42N03-3m9P

# Vishay Siliconix

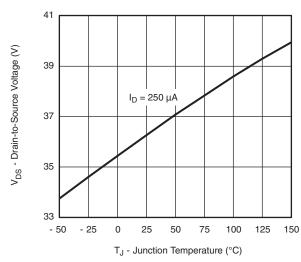
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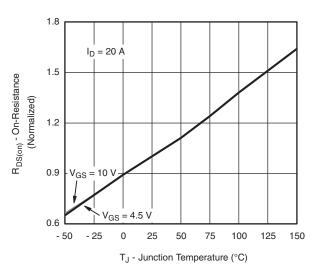


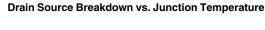


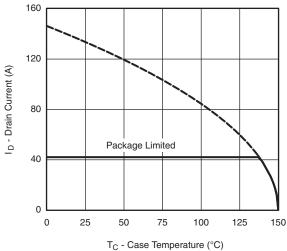


Capacitance







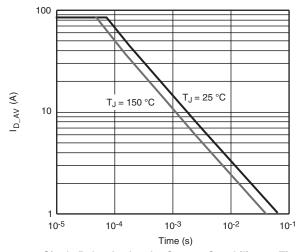


On-Resistance vs. Junction Temperature

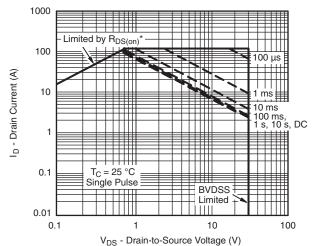


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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

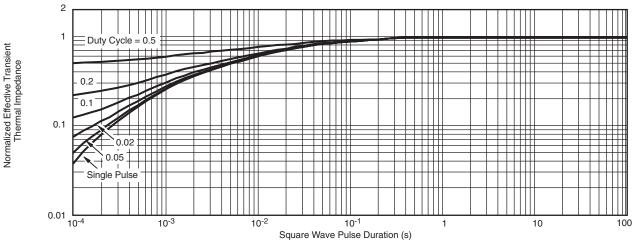


Single Pulse Avalanche Current Capability vs. Time



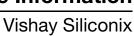
 $^{\star}$  V  $_{GS}$  > minimum V  $_{GS}$  at which R  $_{DS(on)}$  is specified





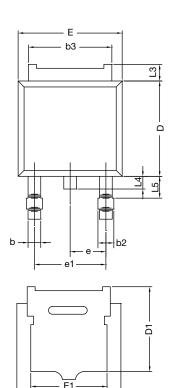
Normalized Thermal Transient Impedance, Junction-to-Case

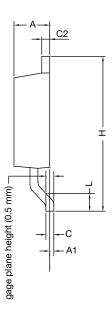
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?66824">www.vishay.com/ppg?66824</a>.





## **TO-252AA Case Outline**





|                                 | MILLIMETERS |       | INCHES    |       |  |
|---------------------------------|-------------|-------|-----------|-------|--|
| DIM.                            | MIN.        | MAX.  | MIN.      | MAX.  |  |
| Α                               | 2.18        | 2.38  | 0.086     | 0.094 |  |
| A1                              | -           | 0.127 | -         | 0.005 |  |
| b                               | 0.64        | 0.88  | 0.025     | 0.035 |  |
| b2                              | 0.76        | 1.14  | 0.030     | 0.045 |  |
| b3                              | 4.95        | 5.46  | 0.195     | 0.215 |  |
| С                               | 0.46        | 0.61  | 0.018     | 0.024 |  |
| C2                              | 0.46        | 0.89  | 0.018     | 0.035 |  |
| D                               | 5.97        | 6.22  | 0.235     | 0.245 |  |
| D1                              | 4.10        | -     | 0.161     | -     |  |
| Е                               | 6.35        | 6.73  | 0.250     | 0.265 |  |
| E1                              | 4.32        | -     | 0.170     | -     |  |
| Н                               | 9.40        | 10.41 | 0.370     | 0.410 |  |
| е                               | 2.28 BSC    |       | 0.090 BSC |       |  |
| e1                              | 4.56        | BSC   | 0.180 BSC |       |  |
| L                               | 1.40        | 1.78  | 0.055     | 0.070 |  |
| L3                              | 0.89        | 1.27  | 0.035     | 0.050 |  |
| L4                              | -           | 1.02  | -         | 0.040 |  |
| L5                              | 1.01        | 1.52  | 0.040     | 0.060 |  |
| ECN: T16-0236-Rev. P, 16-May-16 |             |       |           |       |  |

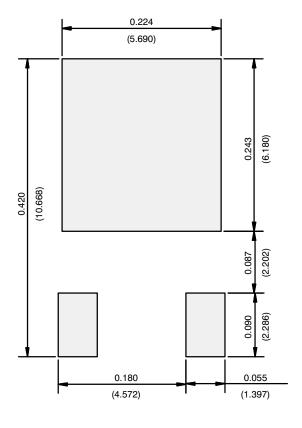
### DWG: 5347

### Notes

• Dimension L3 is for reference only.



## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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